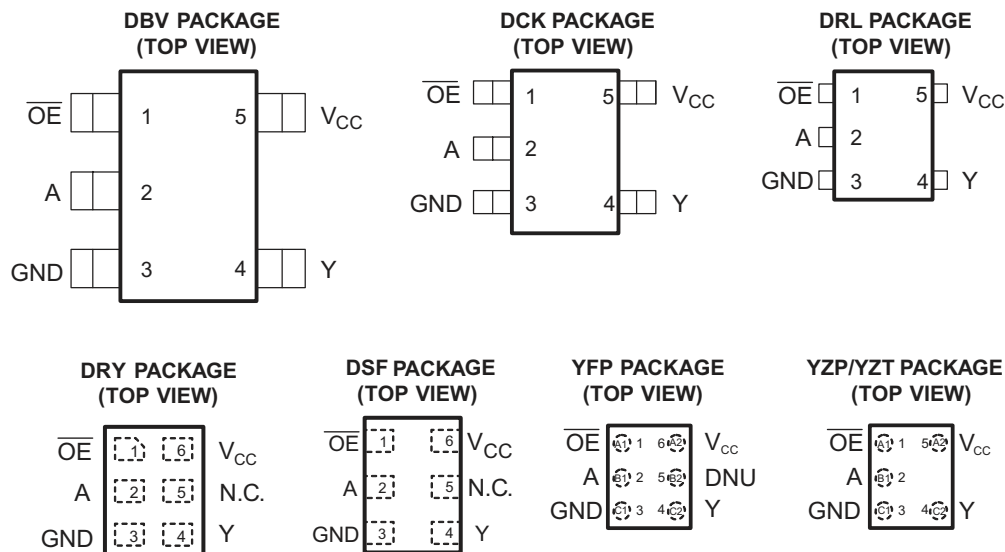


## LOW-POWER SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

Check for Samples: [SN74AUP1G125](#)

### FEATURES

- Available in the Texas Instruments NanoStar™ Package
- Low Static-Power Consumption ( $I_{CC} = 0.9 \mu\text{A Max}$ )
- Low Dynamic-Power Consumption ( $C_{pd} = 4 \text{ pF Typ at } 3.3 \text{ V}$ )
- Low Input Capacitance ( $C_i = 1.5 \text{ pF Typ}$ )
- Low Noise – Overshoot and Undershoot <math><10\% \text{ of } V\_{CC}</math>
- Input-Disable Feature Allows Floating Input Conditions
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Input Hysteresis Allows Slow Input Transition and Better Switching Noise Immunity at Input
- Wide Operating  $V_{CC}$  Range of 0.8 V to 3.6 V
- Optimized for 3.3-V Operation
- 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- $t_{pd} = 4.6 \text{ ns Max at } 3.3 \text{ V}$
- Suitable for Point-to-Point Applications
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)



N.C. – No internal connection.

DNU – Do not use

See mechanical drawings for dimensions.

### DESCRIPTION/ORDERING INFORMATION

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family ensures a very low static and dynamic power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see [Figure 1](#) and [Figure 2](#)).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

NanoStar is a trademark of Texas Instruments.

This bus buffer gate is a single line driver with a 3-state output. The output is disabled when the output-enable ( $\overline{OE}$ ) input is high. This device has the input-disable feature, which allows floating input signals.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

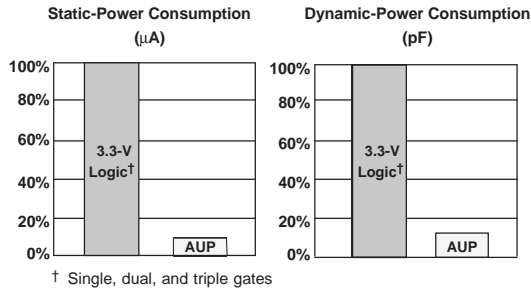


Figure 1. AUP – The Lowest-Power Family

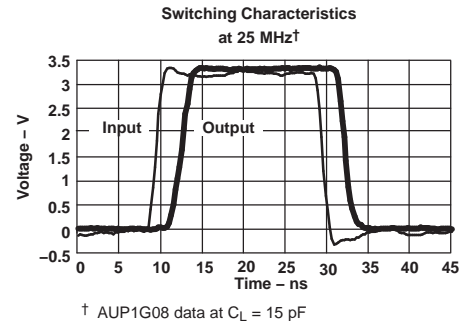


Figure 2. Excellent Signal Integrity

NanoStar™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION<sup>(1)</sup>

| $T_A$               | PACKAGE <sup>(2)</sup>                                         |                  | ORDERABLE PART NUMBER | TOP-SIDE MARKING <sup>(3)</sup> |
|---------------------|----------------------------------------------------------------|------------------|-----------------------|---------------------------------|
| -40°C to 85°C       | NanoStar™ – WCSP (DSBGA)<br>0.23-mm Large Bump – YFP (Pb-free) | Reel of 3000     | SN74AUP1G125YFPR      | ___ HM _                        |
|                     | NanoStar™ – WCSP (DSBGA)<br>0.23-mm Large Bump – YZP (Pb-free) | Reel of 3000     | SN74AUP1G125YZPR      | ___ HM _                        |
|                     | NanoStar™ – WCSP (DSBGA)<br>0.23-mm Large Bump – YZT (Pb-free) | Reel of 3000     | SN74AUP1G125YZTR      | ___ HM _                        |
|                     | QFN – DRY                                                      | Reel of 5000     | SN74AUP1G125DRYR      | HM                              |
|                     | uQFN – DSF                                                     | Reel of 5000     | SN74AUP1G125DSFR      | HM                              |
|                     | SOT (SOT-23) – DBV                                             | Reel of 3000     | SN74AUP1G125DBVR      | H25_                            |
|                     |                                                                | Reel of 250      | SN74AUP1G125DBVT      |                                 |
|                     | SOT (SC-70) – DCK                                              | Reel of 3000     | SN74AUP1G125DCKR      | HM_                             |
| Reel of 250         |                                                                | SN74AUP1G125DCKT |                       |                                 |
| SOT (SOT-553) – DRL | Reel of 4000                                                   | SN74AUP1G125DRLR | HM_                   |                                 |

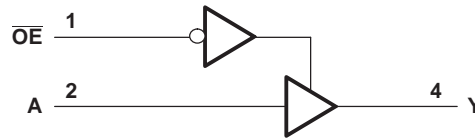
- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).
- (3) DBV/DCK/DRL: The actual top-side marking has one additional character that designates the wafer fab/assembly site.  
YFP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the wafer fab/assembly site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

FUNCTION TABLE

| INPUTS          |                  | OUTPUT |
|-----------------|------------------|--------|
| $\overline{OE}$ | A                | Y      |
| L               | H                | H      |
| L               | L                | L      |
| H               | X <sup>(1)</sup> | Z      |

(1) Floating inputs allowed.

**LOGIC DIAGRAM (POSITIVE LOGIC)**



**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

|               |                                                                                             | MIN             | MAX            | UNIT |
|---------------|---------------------------------------------------------------------------------------------|-----------------|----------------|------|
| $V_{CC}$      | Supply voltage range                                                                        | -0.5            | 4.6            | V    |
| $V_I$         | Input voltage range <sup>(2)</sup>                                                          | -0.5            | 4.6            | V    |
| $V_O$         | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | -0.5            | 4.6            | V    |
| $V_O$         | Output voltage range in the high or low state <sup>(2)</sup>                                | -0.5            | $V_{CC} + 0.5$ | V    |
| $I_{IK}$      | Input clamp current                                                                         | $V_I < 0$       | -50            | mA   |
| $I_{OK}$      | Output clamp current                                                                        | $V_O < 0$       | -50            | mA   |
| $I_O$         | Continuous output current                                                                   |                 | $\pm 20$       | mA   |
|               | Continuous current through $V_{CC}$ or GND                                                  |                 | $\pm 50$       | mA   |
| $\theta_{JA}$ | Package thermal impedance <sup>(3)</sup>                                                    | DBV package     | 206            | °C/W |
|               |                                                                                             | DCK package     | 252            |      |
|               |                                                                                             | DRL package     | 142            |      |
|               |                                                                                             | DSF package     | 300            |      |
|               |                                                                                             | DRY package     | 234            |      |
|               |                                                                                             | YFP/YZP package | 132            |      |
| $T_{stg}$     | Storage temperature range                                                                   | -65             | 150            | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

**RECOMMENDED OPERATING CONDITIONS<sup>(1)</sup>**

|                     |                                    |                                          | <b>MIN</b>           | <b>MAX</b>           | <b>UNIT</b>        |
|---------------------|------------------------------------|------------------------------------------|----------------------|----------------------|--------------------|
| $V_{CC}$            | Supply voltage                     |                                          | 0.8                  | 3.6                  | V                  |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 0.8\text{ V}$                  | $V_{CC}$             | 3.6                  | V                  |
|                     |                                    | $V_{CC} = 1.1\text{ V to }1.95\text{ V}$ | $0.65 \times V_{CC}$ | 3.6                  |                    |
|                     |                                    | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$  | 1.6                  | 3.6                  |                    |
|                     |                                    | $V_{CC} = 3\text{ V to }3.6\text{ V}$    | 2                    | 3.6                  |                    |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 0.8\text{ V}$                  |                      | 0                    | V                  |
|                     |                                    | $V_{CC} = 1.1\text{ V to }1.95\text{ V}$ | 0                    | $0.35 \times V_{CC}$ |                    |
|                     |                                    | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$  | 0                    | 0.7                  |                    |
|                     |                                    | $V_{CC} = 3\text{ V to }3.6\text{ V}$    | 0                    | 0.9                  |                    |
| $V_O$               | Output voltage                     | Active state                             | 0                    | $V_{CC}$             | V                  |
|                     |                                    | 3-state                                  | 0                    | 3.6                  |                    |
| $I_{OH}$            | High-level output current          | $V_{CC} = 0.8\text{ V}$                  |                      | -20                  | $\mu\text{A}$      |
|                     |                                    | $V_{CC} = 1.1\text{ V}$                  |                      | -1.1                 |                    |
|                     |                                    | $V_{CC} = 1.4\text{ V}$                  |                      | -1.7                 | mA                 |
|                     |                                    | $V_{CC} = 1.65\text{ V}$                 |                      | -1.9                 |                    |
|                     |                                    | $V_{CC} = 2.3\text{ V}$                  |                      | -3.1                 |                    |
|                     |                                    | $V_{CC} = 3\text{ V}$                    |                      | -4                   |                    |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 0.8\text{ V}$                  |                      | 20                   | $\mu\text{A}$      |
|                     |                                    | $V_{CC} = 1.1\text{ V}$                  |                      | 1.1                  |                    |
|                     |                                    | $V_{CC} = 1.4\text{ V}$                  |                      | 1.7                  | mA                 |
|                     |                                    | $V_{CC} = 1.65\text{ V}$                 |                      | 1.9                  |                    |
|                     |                                    | $V_{CC} = 2.3\text{ V}$                  |                      | 3.1                  |                    |
|                     |                                    | $V_{CC} = 3\text{ V}$                    |                      | 4                    |                    |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 0.8\text{ V to }3.6\text{ V}$  |                      | 200                  | ns/V               |
| $T_A$               | Operating free-air temperature     |                                          | -40                  | 85                   | $^{\circ}\text{C}$ |

(1) All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number [SCBA004](#).

## ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         | TEST CONDITIONS                   | V <sub>CC</sub>                                                                                         | T <sub>A</sub> = 25°C  |     |     | T <sub>A</sub> = –40°C to 85°C |     | UNIT |
|-------------------|-----------------------------------|---------------------------------------------------------------------------------------------------------|------------------------|-----|-----|--------------------------------|-----|------|
|                   |                                   |                                                                                                         | MIN                    | TYP | MAX | MIN                            | MAX |      |
| V <sub>OL</sub>   | I <sub>OH</sub> = –20 μA          | 0.8 V to 3.6 V                                                                                          | V <sub>CC</sub> – 0.1  |     |     | V <sub>CC</sub> – 0.1          |     | V    |
|                   | I <sub>OH</sub> = –1.1 mA         | 1.1 V                                                                                                   | 0.75 × V <sub>CC</sub> |     |     | 0.7 × V <sub>CC</sub>          |     |      |
|                   | I <sub>OH</sub> = –1.7 mA         | 1.4 V                                                                                                   | 1.11                   |     |     | 1.03                           |     |      |
|                   | I <sub>OH</sub> = –1.9 mA         | 1.65 V                                                                                                  | 1.32                   |     |     | 1.3                            |     |      |
|                   | I <sub>OH</sub> = –2.3 mA         | 2.3 V                                                                                                   | 2.05                   |     |     | 1.97                           |     |      |
|                   | I <sub>OH</sub> = –3.1 mA         |                                                                                                         | 1.9                    |     |     | 1.85                           |     |      |
|                   | I <sub>OH</sub> = –2.7 mA         | 3 V                                                                                                     | 2.72                   |     |     | 2.67                           |     |      |
|                   | I <sub>OH</sub> = –4 mA           |                                                                                                         | 2.6                    |     |     | 2.55                           |     |      |
| V <sub>OL</sub>   | I <sub>OL</sub> = 20 μA           | 0.8 V to 3.6 V                                                                                          |                        |     |     | 0.1                            | 0.1 | V    |
|                   | I <sub>OL</sub> = 1.1 mA          | 1.1 V                                                                                                   | 0.3 × V <sub>CC</sub>  |     |     | 0.3 × V <sub>CC</sub>          |     |      |
|                   | I <sub>OL</sub> = 1.7 mA          | 1.4 V                                                                                                   | 0.31                   |     |     | 0.37                           |     |      |
|                   | I <sub>OL</sub> = 1.9 mA          | 1.65 V                                                                                                  | 0.31                   |     |     | 0.35                           |     |      |
|                   | I <sub>OL</sub> = 2.3 mA          | 2.3 V                                                                                                   | 0.31                   |     |     | 0.33                           |     |      |
|                   | I <sub>OL</sub> = 3.1 mA          |                                                                                                         | 0.44                   |     |     | 0.45                           |     |      |
|                   | I <sub>OL</sub> = 2.7 mA          | 3 V                                                                                                     | 0.31                   |     |     | 0.33                           |     |      |
|                   | I <sub>OL</sub> = 4 mA            |                                                                                                         | 0.44                   |     |     | 0.45                           |     |      |
| I <sub>I</sub>    | A or $\overline{\text{OE}}$ input | V <sub>I</sub> = GND to 3.6 V                                                                           | 0 V to 3.6 V           |     |     | 0.1                            | 0.5 | μA   |
| I <sub>off</sub>  |                                   | V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V                                                         | 0 V                    |     |     | 0.2                            | 0.6 | μA   |
| ΔI <sub>off</sub> |                                   | V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V                                                         | 0 V to 0.2 V           |     |     | 0.2                            | 0.6 | μA   |
| I <sub>OZ</sub>   |                                   | V <sub>O</sub> = V <sub>CC</sub> or GND                                                                 | 3.6 V                  |     |     | 0.1                            | 0.5 | μA   |
| I <sub>CC</sub>   |                                   | V <sub>I</sub> = GND or (V <sub>CC</sub> to 3.6 V),<br>$\overline{\text{OE}}$ = GND, I <sub>O</sub> = 0 | 0.8 V to 3.6 V         |     |     | 0.5                            | 0.9 | μA   |
| ΔI <sub>CC</sub>  | A input                           | V <sub>I</sub> = V <sub>CC</sub> – 0.6 V <sup>(1)</sup> ,<br>I <sub>O</sub> = 0                         | 3.3 V                  |     |     | 40                             | 50  | μA   |
|                   | $\overline{\text{OE}}$ input      |                                                                                                         |                        |     |     | 110                            | 120 |      |
|                   | All inputs                        | V <sub>I</sub> = GND to 3.6 V,<br>$\overline{\text{OE}}$ = V <sub>CC</sub> <sup>(2)</sup>               | 0.8 V to 3.6 V         |     |     | 0                              | 0   |      |
| C <sub>I</sub>    |                                   | V <sub>I</sub> = V <sub>CC</sub> or GND                                                                 | 0 V                    |     |     | 1.5                            |     | pF   |
|                   |                                   |                                                                                                         | 3.6 V                  |     |     | 1.5                            |     |      |
| C <sub>O</sub>    |                                   | V <sub>O</sub> = V <sub>CC</sub> or GND                                                                 | 3.6 V                  |     |     | 3                              |     | pF   |

 (1) One input at V<sub>CC</sub> – 0.6 V, other input at V<sub>CC</sub> or GND

 (2) To show I<sub>CC</sub> is very low when the input-disable feature is enabled

**SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range,  $C_L = 5$  pF (unless otherwise noted) (see [Figure 3](#) and [Figure 4](#))

| PARAMETER | FROM<br>(INPUT)        | TO<br>(OUTPUT) | $V_{CC}$                         | $T_A = 25^\circ\text{C}$ |      |      | $T_A = -40^\circ\text{C}$<br>to $85^\circ\text{C}$ |      | UNIT |
|-----------|------------------------|----------------|----------------------------------|--------------------------|------|------|----------------------------------------------------|------|------|
|           |                        |                |                                  | MIN                      | TYP  | MAX  | MIN                                                | MAX  |      |
| $t_{pd}$  | A                      | Y              | 0.8 V                            |                          | 18.1 |      |                                                    |      | ns   |
|           |                        |                | $1.2\text{ V} \pm 0.1\text{ V}$  | 4.3                      | 7.4  | 12.6 | 2.7                                                | 15.3 |      |
|           |                        |                | $1.5\text{ V} \pm 0.1\text{ V}$  | 3.3                      | 5.2  | 8.5  | 1                                                  | 10.2 |      |
|           |                        |                | $1.8\text{ V} \pm 0.15\text{ V}$ | 2.6                      | 4.1  | 6.8  | 1.3                                                | 8.3  |      |
|           |                        |                | $2.5\text{ V} \pm 0.2\text{ V}$  | 2                        | 2.9  | 4.7  | 1.1                                                | 5.8  |      |
|           |                        |                | $3.3\text{ V} \pm 0.3\text{ V}$  | 1.7                      | 2.4  | 3.8  | 1                                                  | 4.6  |      |
| $t_{en}$  | $\overline{\text{OE}}$ | Y              | 0.8 V                            |                          | 19.1 |      |                                                    | ns   |      |
|           |                        |                | $1.2\text{ V} \pm 0.1\text{ V}$  | 5.1                      | 9.3  | 15.9 | 3.6                                                |      | 19.2 |
|           |                        |                | $1.5\text{ V} \pm 0.1\text{ V}$  | 4.1                      | 6.6  | 10.5 | 2.5                                                |      | 12.7 |
|           |                        |                | $1.8\text{ V} \pm 0.15\text{ V}$ | 3.2                      | 5.3  | 8.7  | 2.1                                                |      | 10.3 |
|           |                        |                | $2.5\text{ V} \pm 0.2\text{ V}$  | 2.5                      | 3.8  | 6    | 1.6                                                |      | 7.2  |
|           |                        |                | $3.3\text{ V} \pm 0.3\text{ V}$  | 2.1                      | 3.2  | 4.9  | 1.4                                                |      | 5.9  |
| $t_{dis}$ | $\overline{\text{OE}}$ | Y              | 0.8 V                            |                          | 12.1 |      |                                                    | ns   |      |
|           |                        |                | $1.2\text{ V} \pm 0.1\text{ V}$  | 2.4                      | 4.1  | 6.9  | 2.2                                                |      | 7.7  |
|           |                        |                | $1.5\text{ V} \pm 0.1\text{ V}$  | 1.8                      | 2.9  | 4.5  | 1.7                                                |      | 5.1  |
|           |                        |                | $1.8\text{ V} \pm 0.15\text{ V}$ | 1                        | 2.9  | 4.3  | 1.5                                                |      | 4.7  |
|           |                        |                | $2.5\text{ V} \pm 0.2\text{ V}$  | 1                        | 1.8  | 2.7  | 1                                                  |      | 3.3  |
|           |                        |                | $3.3\text{ V} \pm 0.3\text{ V}$  | 1.2                      | 2.2  | 3.2  | 1.1                                                |      | 4    |

**SWITCHING CHARACTERISTICS**

 over recommended operating free-air temperature range,  $C_L = 10$  pF (unless otherwise noted) (see [Figure 3](#) and [Figure 4](#))

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | $V_{CC}$                         | $T_A = 25^\circ\text{C}$ |      |      | $T_A = -40^\circ\text{C}$<br>to $85^\circ\text{C}$ |      | UNIT |
|-----------|-----------------|-------------|----------------------------------|--------------------------|------|------|----------------------------------------------------|------|------|
|           |                 |             |                                  | MIN                      | TYP  | MAX  | MIN                                                | MAX  |      |
| $t_{pd}$  | A or B          | Y           | 0.8 V                            |                          | 20.5 |      |                                                    |      | ns   |
|           |                 |             | $1.2\text{ V} \pm 0.1\text{ V}$  | 4.6                      | 8.4  | 13.7 | 3.6                                                | 16.6 |      |
|           |                 |             | $1.5\text{ V} \pm 0.1\text{ V}$  | 3.5                      | 5.9  | 9.3  | 2.4                                                | 11.1 |      |
|           |                 |             | $1.8\text{ V} \pm 0.15\text{ V}$ | 3.9                      | 4.7  | 7.5  | 1.3                                                | 9.1  |      |
|           |                 |             | $2.5\text{ V} \pm 0.2\text{ V}$  | 2.3                      | 3.4  | 5.3  | 1.6                                                | 6.4  |      |
|           |                 |             | $3.3\text{ V} \pm 0.3\text{ V}$  | 2.1                      | 2.8  | 4.3  | 1.4                                                | 5.2  |      |
| $t_{en}$  | $\overline{OE}$ | Y           | 0.8 V                            |                          | 21.8 |      |                                                    | ns   |      |
|           |                 |             | $1.2\text{ V} \pm 0.1\text{ V}$  | 4.9                      | 10.2 | 16.8 | 4.4                                                |      | 20.2 |
|           |                 |             | $1.5\text{ V} \pm 0.1\text{ V}$  | 3.9                      | 7.3  | 11.2 | 3.3                                                |      | 13.5 |
|           |                 |             | $1.8\text{ V} \pm 0.15\text{ V}$ | 3.4                      | 5.8  | 9.2  | 2.7                                                |      | 11   |
|           |                 |             | $2.5\text{ V} \pm 0.2\text{ V}$  | 2.5                      | 4.3  | 6.4  | 2.1                                                |      | 7.8  |
|           |                 |             | $3.3\text{ V} \pm 0.3\text{ V}$  | 2.1                      | 3.7  | 5.4  | 1.9                                                |      | 6.4  |
| $t_{dis}$ | $\overline{OE}$ | Y           | 0.8 V                            |                          | 13   |      |                                                    | ns   |      |
|           |                 |             | $1.2\text{ V} \pm 0.1\text{ V}$  | 3.8                      | 6.6  | 11.7 | 1.2                                                |      | 14   |
|           |                 |             | $1.5\text{ V} \pm 0.1\text{ V}$  | 2.2                      | 4.7  | 7.9  | 1.3                                                |      | 9.3  |
|           |                 |             | $1.8\text{ V} \pm 0.15\text{ V}$ | 2.4                      | 4.4  | 6.4  | 2.2                                                |      | 7.5  |
|           |                 |             | $2.5\text{ V} \pm 0.2\text{ V}$  | 1.3                      | 3.1  | 4.9  | 1.2                                                |      | 5.4  |
|           |                 |             | $3.3\text{ V} \pm 0.3\text{ V}$  | 1.9                      | 3.4  | 5    | 1.9                                                |      | 5.6  |

**SWITCHING CHARACTERISTICS**

 over recommended operating free-air temperature range,  $C_L = 15$  pF (unless otherwise noted) (see [Figure 3](#) and [Figure 4](#))

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | $V_{CC}$                         | $T_A = 25^\circ\text{C}$ |      |      | $T_A = -40^\circ\text{C}$<br>to $85^\circ\text{C}$ |     | UNIT |
|-----------|-----------------|-------------|----------------------------------|--------------------------|------|------|----------------------------------------------------|-----|------|
|           |                 |             |                                  | MIN                      | TYP  | MAX  | MIN                                                | MAX |      |
| $t_{pd}$  | A or B          | Y           | 0.8 V                            |                          | 22.5 |      |                                                    | ns  |      |
|           |                 |             | $1.2\text{ V} \pm 0.1\text{ V}$  | 5.8                      | 9.3  | 15.1 | 4.3                                                |     | 17.9 |
|           |                 |             | $1.5\text{ V} \pm 0.1\text{ V}$  | 4.4                      | 6.6  | 10.2 | 3                                                  |     | 12.1 |
|           |                 |             | $1.8\text{ V} \pm 0.15\text{ V}$ | 3.5                      | 5.3  | 8.3  | 2.3                                                |     | 9.9  |
|           |                 |             | $2.5\text{ V} \pm 0.2\text{ V}$  | 2.7                      | 3.9  | 5.8  | 1.9                                                |     | 7    |
|           |                 |             | $3.3\text{ V} \pm 0.3\text{ V}$  | 2.4                      | 3.2  | 4.7  | 1.8                                                |     | 5.7  |
| $t_{en}$  | $\overline{OE}$ | Y           | 0.8 V                            |                          | 25.2 |      |                                                    | ns  |      |
|           |                 |             | $1.2\text{ V} \pm 0.1\text{ V}$  | 7                        | 11.3 | 18.1 | 5.4                                                |     | 21.4 |
|           |                 |             | $1.5\text{ V} \pm 0.1\text{ V}$  | 5.5                      | 8.1  | 12.2 | 4.1                                                |     | 14.5 |
|           |                 |             | $1.8\text{ V} \pm 0.15\text{ V}$ | 4.3                      | 6.5  | 10.1 | 3.3                                                |     | 12   |
|           |                 |             | $2.5\text{ V} \pm 0.2\text{ V}$  | 3.4                      | 4.8  | 7.1  | 2.6                                                |     | 8.4  |
|           |                 |             | $3.3\text{ V} \pm 0.3\text{ V}$  | 2.9                      | 4.1  | 5.9  | 2.3                                                |     | 6.9  |
| $t_{dis}$ | $\overline{OE}$ | Y           | 0.8 V                            |                          | 14   |      |                                                    | ns  |      |
|           |                 |             | $1.2\text{ V} \pm 0.1\text{ V}$  | 3.7                      | 5.8  | 8.2  | 3.3                                                |     | 11   |
|           |                 |             | $1.5\text{ V} \pm 0.1\text{ V}$  | 5.5                      | 3.9  | 5.9  | 2.1                                                |     | 8    |
|           |                 |             | $1.8\text{ V} \pm 0.15\text{ V}$ | 3.3                      | 4.5  | 6.6  | 2.9                                                |     | 7.4  |
|           |                 |             | $2.5\text{ V} \pm 0.2\text{ V}$  | 2.3                      | 3.2  | 4.3  | 1.8                                                |     | 5.1  |
|           |                 |             | $3.3\text{ V} \pm 0.3\text{ V}$  | 2.4                      | 4.8  | 6.2  | 3.1                                                |     | 6.7  |

**SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  (unless otherwise noted) (see [Figure 3](#) and [Figure 4](#))

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | $V_{CC}$                           | $T_A = 25^\circ\text{C}$ |      |      | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$ |      | UNIT |
|-----------|-----------------|-------------|------------------------------------|--------------------------|------|------|-------------------------------------------------|------|------|
|           |                 |             |                                    | MIN                      | TYP  | MAX  | MIN                                             | MAX  |      |
| $t_{pd}$  | A or B          | Y           | 0.8 V                              |                          | 29   |      |                                                 |      | ns   |
|           |                 |             | $1.2 \text{ V} \pm 0.1 \text{ V}$  | 7.4                      | 12   | 18.7 | 6.6                                             | 21.4 |      |
|           |                 |             | $1.5 \text{ V} \pm 0.1 \text{ V}$  | 5.7                      | 8.6  | 12.5 | 4.9                                             | 14.7 |      |
|           |                 |             | $1.8 \text{ V} \pm 0.15 \text{ V}$ | 4.8                      | 6.9  | 10.1 | 3.1                                             | 12   |      |
|           |                 |             | $2.5 \text{ V} \pm 0.2 \text{ V}$  | 3.9                      | 5.1  | 7.2  | 3.3                                             | 8.7  |      |
|           |                 |             | $3.3 \text{ V} \pm 0.3 \text{ V}$  | 3.5                      | 4.8  | 6    | 3                                               | 7    |      |
| $t_{en}$  | $\overline{OE}$ | Y           | 0.8 V                              |                          | 33.4 |      |                                                 |      | ns   |
|           |                 |             | $1.2 \text{ V} \pm 0.1 \text{ V}$  | 8.8                      | 14.1 | 21.8 | 7.4                                             | 25.5 |      |
|           |                 |             | $1.5 \text{ V} \pm 0.1 \text{ V}$  | 6.9                      | 10.1 | 14.6 | 5.6                                             | 17.4 |      |
|           |                 |             | $1.8 \text{ V} \pm 0.15 \text{ V}$ | 5.6                      | 8.1  | 12   | 4.7                                             | 14.1 |      |
|           |                 |             | $2.5 \text{ V} \pm 0.2 \text{ V}$  | 4.3                      | 6.1  | 8.5  | 3.8                                             | 10   |      |
|           |                 |             | $3.3 \text{ V} \pm 0.3 \text{ V}$  | 3.7                      | 5.2  | 7.1  | 3.4                                             | 8.3  |      |
| $t_{dis}$ | $\overline{OE}$ | Y           | 0.8 V                              |                          | 17.7 |      |                                                 |      | ns   |
|           |                 |             | $1.2 \text{ V} \pm 0.1 \text{ V}$  | 5.8                      | 10   | 16   | 3.7                                             | 16   |      |
|           |                 |             | $1.5 \text{ V} \pm 0.1 \text{ V}$  | 5.7                      | 7.7  | 10.9 | 1                                               | 10.7 |      |
|           |                 |             | $1.8 \text{ V} \pm 0.15 \text{ V}$ | 4.5                      | 7.7  | 9.8  | 4.4                                             | 12.5 |      |
|           |                 |             | $2.5 \text{ V} \pm 0.2 \text{ V}$  | 3.9                      | 5.6  | 7.4  | 3.2                                             | 9    |      |
|           |                 |             | $3.3 \text{ V} \pm 0.3 \text{ V}$  | 3.3                      | 8.4  | 10.7 | 6.6                                             | 10.8 |      |

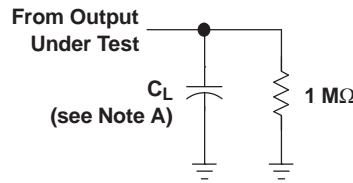
**OPERATING CHARACTERISTICS**

$T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS      | $V_{CC}$                           | TYP                                | UNIT |    |
|-----------|-------------------------------|----------------------|------------------------------------|------------------------------------|------|----|
| $C_{pd}$  | Power dissipation capacitance | Outputs enabled      | $f = 10 \text{ MHz}$               | 0.8 V                              | 3.8  | pF |
|           |                               |                      |                                    | $1.2 \text{ V} \pm 0.1 \text{ V}$  | 3.8  |    |
|           |                               |                      |                                    | $1.5 \text{ V} \pm 0.1 \text{ V}$  | 3.7  |    |
|           |                               |                      |                                    | $1.8 \text{ V} \pm 0.15 \text{ V}$ | 3.8  |    |
|           |                               |                      |                                    | $2.5 \text{ V} \pm 0.2 \text{ V}$  | 3.9  |    |
|           |                               |                      |                                    | $3.3 \text{ V} \pm 0.3 \text{ V}$  | 4    |    |
|           | Outputs disabled              | $f = 10 \text{ MHz}$ | 0.8 V                              | 0                                  |      |    |
|           |                               |                      | $1.2 \text{ V} \pm 0.1 \text{ V}$  | 0                                  |      |    |
|           |                               |                      | $1.5 \text{ V} \pm 0.1 \text{ V}$  | 0                                  |      |    |
|           |                               |                      | $1.8 \text{ V} \pm 0.15 \text{ V}$ | 0                                  |      |    |
|           |                               |                      | $2.5 \text{ V} \pm 0.2 \text{ V}$  | 0                                  |      |    |
|           |                               |                      | $3.3 \text{ V} \pm 0.3 \text{ V}$  | 0                                  |      |    |

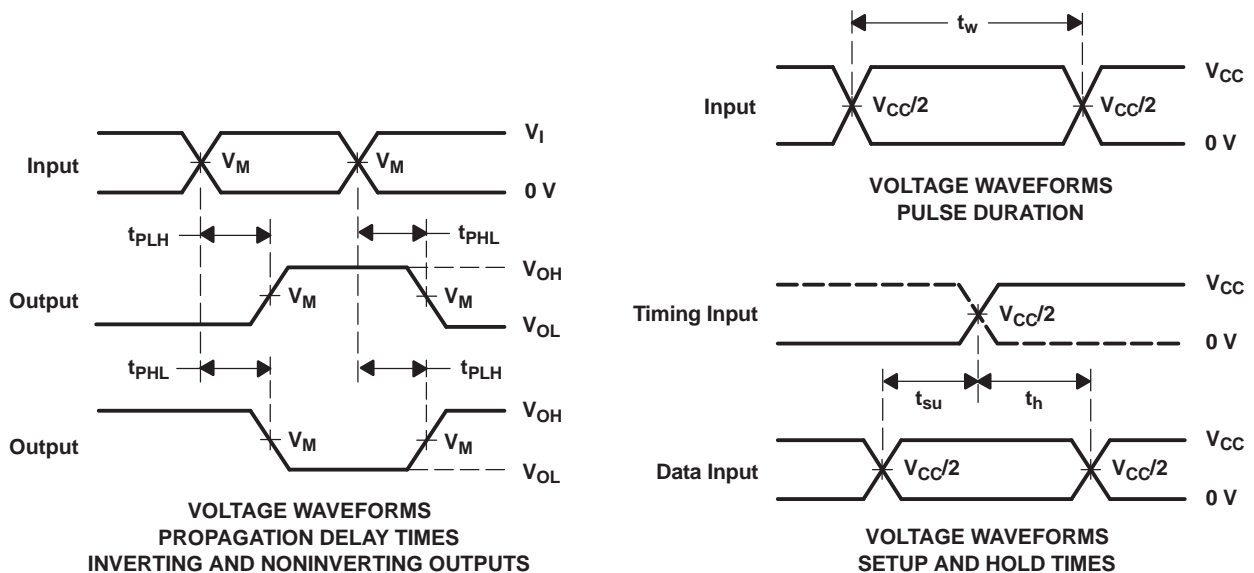


**PARAMETER MEASUREMENT INFORMATION**  
(Propagation Delays, Setup and Hold Times, and Pulse Duration)



LOAD CIRCUIT

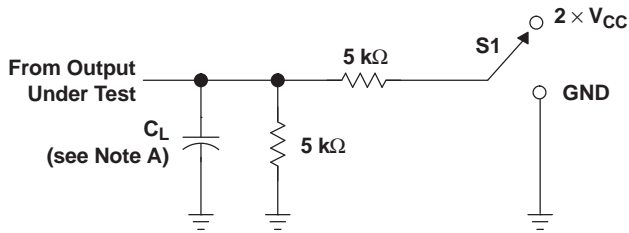
|       | $V_{CC} = 0.8\text{ V}$ | $V_{CC} = 1.2\text{ V}$<br>$\pm 0.1\text{ V}$ | $V_{CC} = 1.5\text{ V}$<br>$\pm 0.1\text{ V}$ | $V_{CC} = 1.8\text{ V}$<br>$\pm 0.15\text{ V}$ | $V_{CC} = 2.5\text{ V}$<br>$\pm 0.2\text{ V}$ | $V_{CC} = 3.3\text{ V}$<br>$\pm 0.3\text{ V}$ |
|-------|-------------------------|-----------------------------------------------|-----------------------------------------------|------------------------------------------------|-----------------------------------------------|-----------------------------------------------|
| $C_L$ | 5, 10, 15, 30 pF        | 5, 10, 15, 30 pF                              | 5, 10, 15, 30 pF                              | 5, 10, 15, 30 pF                               | 5, 10, 15, 30 pF                              | 5, 10, 15, 30 pF                              |
| $V_M$ | $V_{CC}/2$              | $V_{CC}/2$                                    | $V_{CC}/2$                                    | $V_{CC}/2$                                     | $V_{CC}/2$                                    | $V_{CC}/2$                                    |
| $V_I$ | $V_{CC}$                | $V_{CC}$                                      | $V_{CC}$                                      | $V_{CC}$                                       | $V_{CC}$                                      | $V_{CC}$                                      |



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10$  MHz,  $Z_O = 50\ \Omega$ ,  $t_r/t_f = 3$  ns.  
 C. The outputs are measured one at a time, with one transition per measurement.  
 D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .  
 E. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

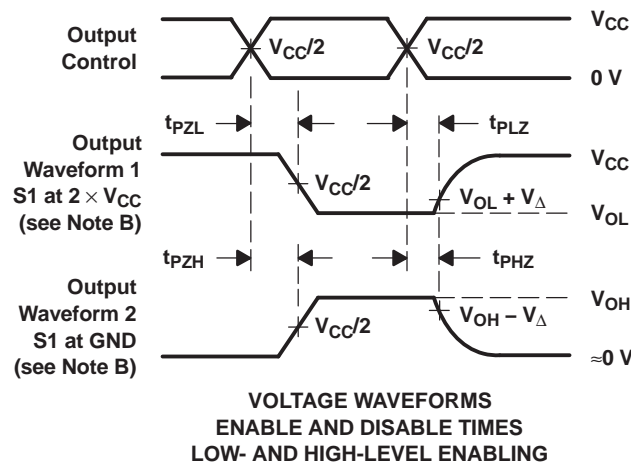
**PARAMETER MEASUREMENT INFORMATION  
(Enable and Disable Times)**



| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |

**LOAD CIRCUIT**

|              | $V_{CC} = 0.8 \text{ V}$ | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |
|--------------|--------------------------|--------------------------------------------|--------------------------------------------|---------------------------------------------|--------------------------------------------|--------------------------------------------|
| $C_L$        | 5, 10, 15, 30 pF         | 5, 10, 15, 30 pF                           | 5, 10, 15, 30 pF                           | 5, 10, 15, 30 pF                            | 5, 10, 15, 30 pF                           | 5, 10, 15, 30 pF                           |
| $V_M$        | $V_{CC}/2$               | $V_{CC}/2$                                 | $V_{CC}/2$                                 | $V_{CC}/2$                                  | $V_{CC}/2$                                 | $V_{CC}/2$                                 |
| $V_I$        | $V_{CC}$                 | $V_{CC}$                                   | $V_{CC}$                                   | $V_{CC}$                                    | $V_{CC}$                                   | $V_{CC}$                                   |
| $V_{\Delta}$ | 0.1 V                    | 0.1 V                                      | 0.1 V                                      | 0.15 V                                      | 0.15 V                                     | 0.3 V                                      |



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r/t_f = 3 \text{ ns}$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G. All parameters and waveforms are not applicable to all devices.

**Figure 4. Load Circuit and Voltage Waveforms**

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## REVISION HISTORY

| Changes from Revision K (November 2012) to Revision L           | Page |
|-----------------------------------------------------------------|------|
| • Changed $\bar{Y}$ to Y for pin 4 in DSF Package pin out ..... | 1    |

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**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| 74AUP1G125DBVRE4 | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | H25R                     | <a href="#">Samples</a> |
| 74AUP1G125DBVRG4 | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | H25R                     | <a href="#">Samples</a> |
| 74AUP1G125DBVTE4 | ACTIVE        | SOT-23       | DBV             | 5    | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | H25R                     | <a href="#">Samples</a> |
| 74AUP1G125DBVTG4 | ACTIVE        | SOT-23       | DBV             | 5    | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | H25R                     | <a href="#">Samples</a> |
| 74AUP1G125DCKRE4 | ACTIVE        | SC70         | DCK             | 5    | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM5 ~ HMF ~ HMK ~ HMR)  | <a href="#">Samples</a> |
| 74AUP1G125DCKRG4 | ACTIVE        | SC70         | DCK             | 5    | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM5 ~ HMF ~ HMK ~ HMR)  | <a href="#">Samples</a> |
| 74AUP1G125DCKTE4 | ACTIVE        | SC70         | DCK             | 5    | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM5 ~ HMR)              | <a href="#">Samples</a> |
| 74AUP1G125DCKTG4 | ACTIVE        | SC70         | DCK             | 5    | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM5 ~ HMR)              | <a href="#">Samples</a> |
| 74AUP1G125DRLRG4 | ACTIVE        | SOT          | DRL             | 5    | 4000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM7 ~ HMR)              | <a href="#">Samples</a> |
| SN74AUP1G125DBVR | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | H25R                     | <a href="#">Samples</a> |
| SN74AUP1G125DBVT | ACTIVE        | SOT-23       | DBV             | 5    | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | H25R                     | <a href="#">Samples</a> |
| SN74AUP1G125DCKR | ACTIVE        | SC70         | DCK             | 5    | 3000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM5 ~ HMF ~ HMK ~ HMR)  | <a href="#">Samples</a> |
| SN74AUP1G125DCKT | ACTIVE        | SC70         | DCK             | 5    | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM5 ~ HMR)              | <a href="#">Samples</a> |
| SN74AUP1G125DRLR | ACTIVE        | SOT          | DRL             | 5    | 4000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | (HM7 ~ HMR)              | <a href="#">Samples</a> |
| SN74AUP1G125DRYR | ACTIVE        | SON          | DRY             | 6    | 5000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | HM                       | <a href="#">Samples</a> |
| SN74AUP1G125DSFR | ACTIVE        | SON          | DSF             | 6    | 5000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | HM                       | <a href="#">Samples</a> |
| SN74AUP1G125YFPR | ACTIVE        | DSBGA        | YFP             | 6    | 3000        | Green (RoHS & no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM   |              | (HM2 ~ HM7 ~ HMN)        | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| SN74AUP1G125YZPR | ACTIVE        | DSBGA        | YZP                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM   | -40 to 85    | (HM7 ~ HMN)              | <a href="#">Samples</a> |
| SN74AUP1G125YZTR | ACTIVE        | DSBGA        | YZT                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM   | -40 to 85    | (HM ~ HM2 ~ HM7)         | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AUP1G125DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DBVT | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DCKR | SC70         | DCK             | 5    | 3000 | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DCKR | SC70         | DCK             | 5    | 3000 | 180.0              | 9.2                | 2.3     | 2.55    | 1.2     | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DCKT | SC70         | DCK             | 5    | 250  | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DRLR | SOT          | DRL             | 5    | 4000 | 180.0              | 9.5                | 1.78    | 1.78    | 0.69    | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DRLR | SOT          | DRL             | 5    | 4000 | 180.0              | 8.4                | 1.98    | 1.78    | 0.69    | 4.0     | 8.0    | Q3            |
| SN74AUP1G125DRYR | SON          | DRY             | 6    | 5000 | 180.0              | 9.5                | 1.15    | 1.6     | 0.75    | 4.0     | 8.0    | Q1            |
| SN74AUP1G125DSFR | SON          | DSF             | 6    | 5000 | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| SN74AUP1G125YFPR | DSBGA        | YFP             | 6    | 3000 | 178.0              | 9.2                | 0.89    | 1.29    | 0.62    | 4.0     | 8.0    | Q1            |
| SN74AUP1G125YZPR | DSBGA        | YZP             | 5    | 3000 | 178.0              | 9.2                | 1.02    | 1.52    | 0.63    | 4.0     | 8.0    | Q1            |
| SN74AUP1G125YZTR | DSBGA        | YZT             | 5    | 3000 | 180.0              | 8.4                | 1.02    | 1.52    | 0.75    | 4.0     | 8.0    | Q1            |

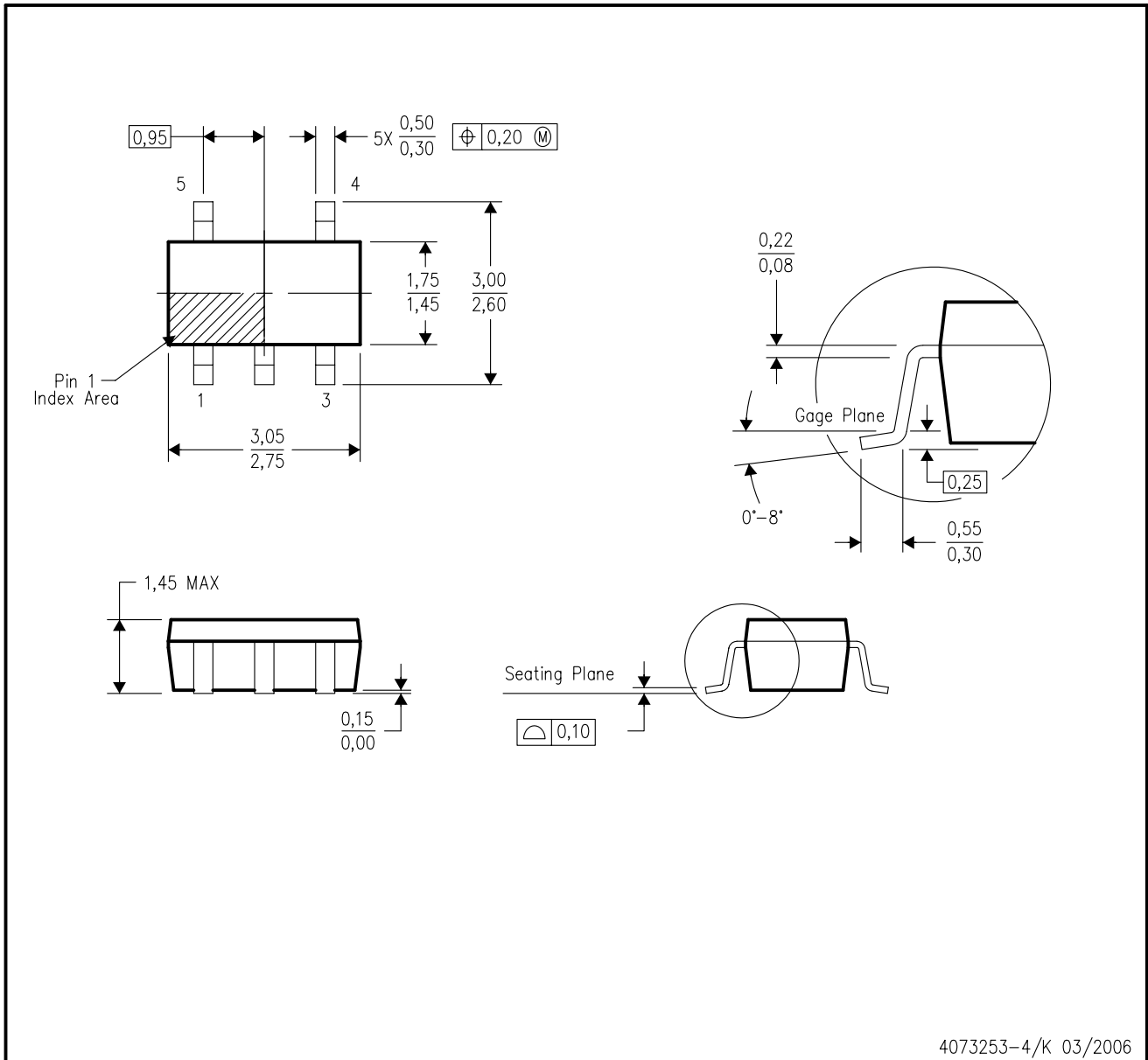
**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AUP1G125DBVR | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DBVT | SOT-23       | DBV             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DCKR | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AUP1G125DCKR | SC70         | DCK             | 5    | 3000 | 205.0       | 200.0      | 33.0        |
| SN74AUP1G125DCKT | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AUP1G125DRLR | SOT          | DRL             | 5    | 4000 | 180.0       | 180.0      | 30.0        |
| SN74AUP1G125DRLR | SOT          | DRL             | 5    | 4000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G125DRYR | SON          | DRY             | 6    | 5000 | 180.0       | 180.0      | 30.0        |
| SN74AUP1G125DSFR | SON          | DSF             | 6    | 5000 | 180.0       | 180.0      | 30.0        |
| SN74AUP1G125YFPR | DSBGA        | YFP             | 6    | 3000 | 220.0       | 220.0      | 35.0        |
| SN74AUP1G125YZPR | DSBGA        | YZP             | 5    | 3000 | 220.0       | 220.0      | 35.0        |
| SN74AUP1G125YZTR | DSBGA        | YZT             | 5    | 3000 | 210.0       | 185.0      | 35.0        |

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



4073253-4/K 03/2006

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-178 Variation AA.



DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

DCK (R-PDSO-G5)

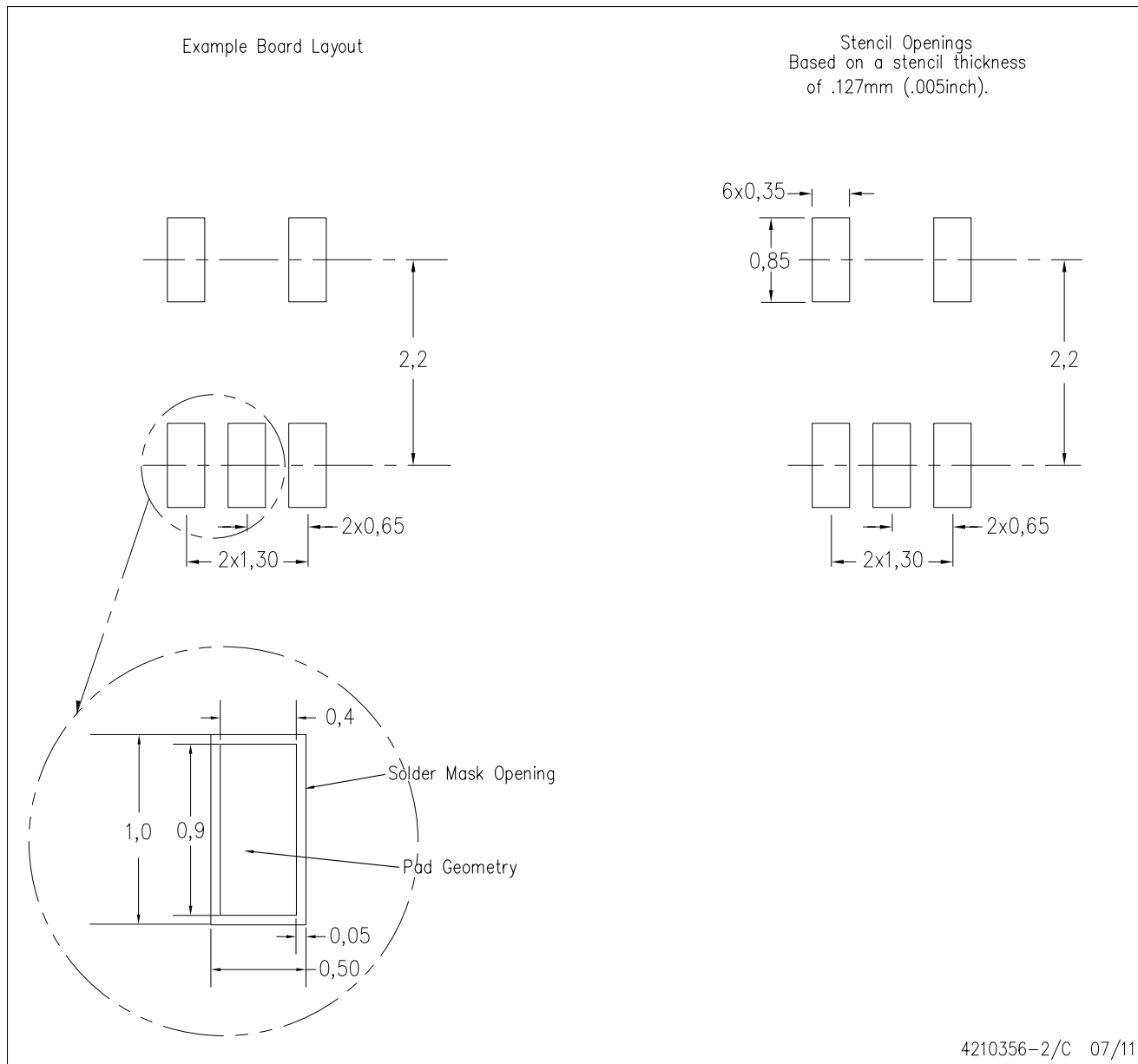
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-203 variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



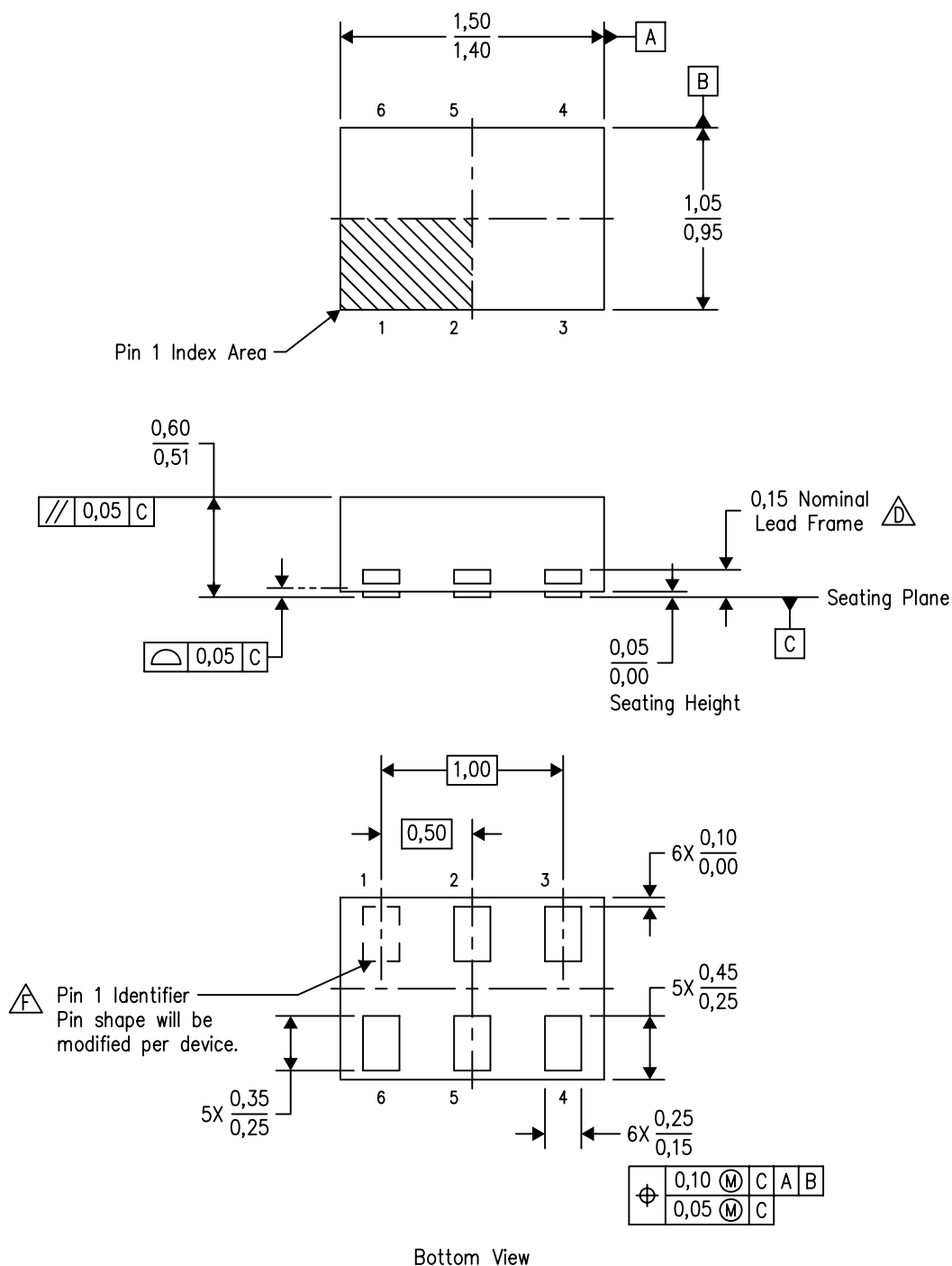
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash, interlead flash, protrusions, or gate burrs. Mold flash, interlead flash, protrusions, or gate burrs shall not exceed 0,15 per end or side.
  - D. JEDEC package registration is pending.



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
  - E. Maximum stencil thickness 0,127 mm (5 mils). All linear dimensions are in millimeters.
  - F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - G. Side aperture dimensions over-print land for acceptable area ratio > 0.66. Customer may reduce side aperture dimensions if stencil manufacturing process allows for sufficient release at smaller opening.

DRY (R-PUSON-N6)

PLASTIC SMALL OUTLINE NO-LEAD

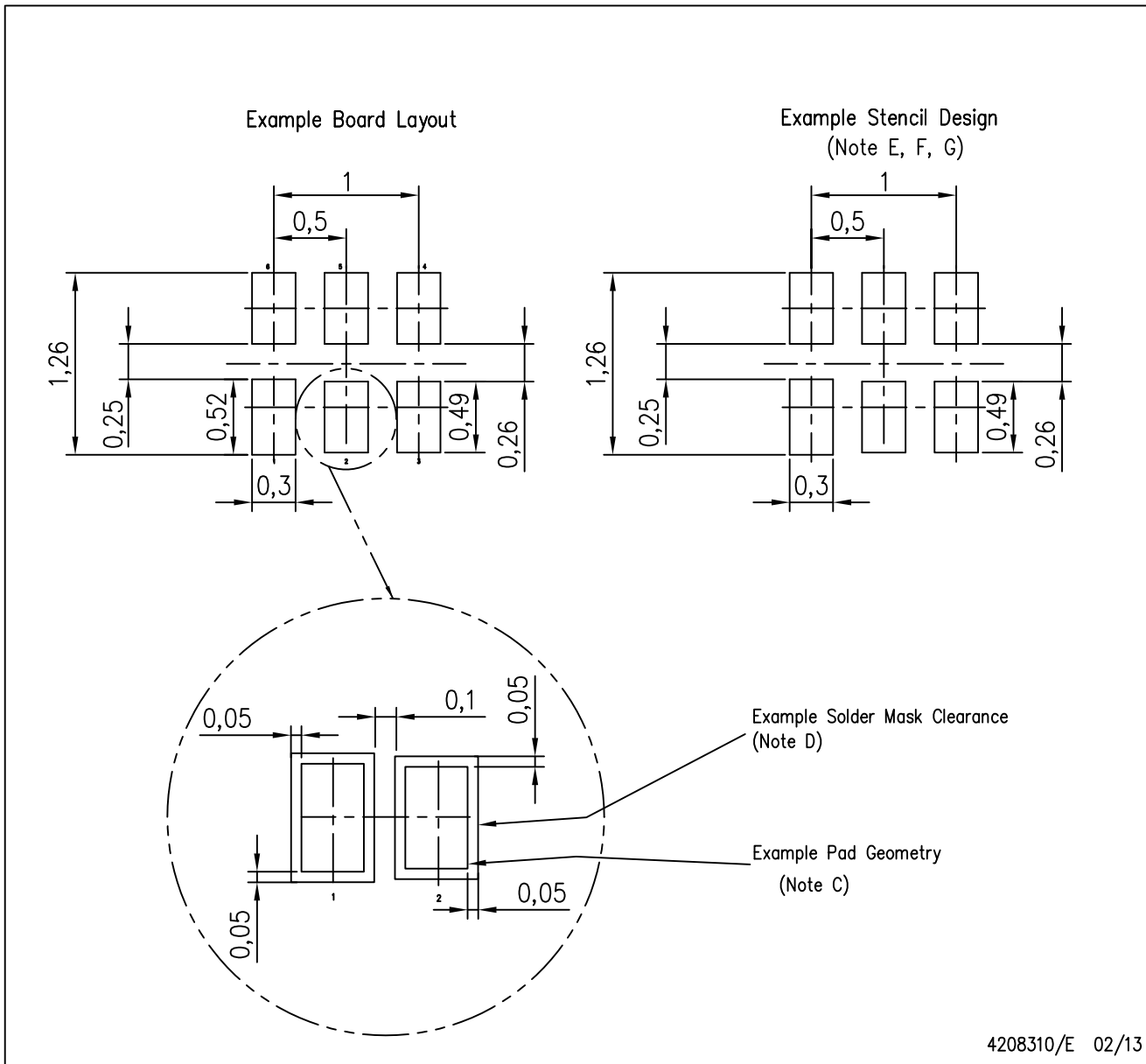


4207181/F 12/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. SON (Small Outline No-Lead) package configuration.
  - $\triangle D$  The exposed lead frame feature on side of package may or may not be present due to alternative lead frame designs.
  - E. This package complies to JEDEC MO-287 variation UFAD.
  - $\triangle F$  See the additional figure in the Product Data Sheet for details regarding the pin 1 identifier shape.

DRY (R-PUSON-N6)

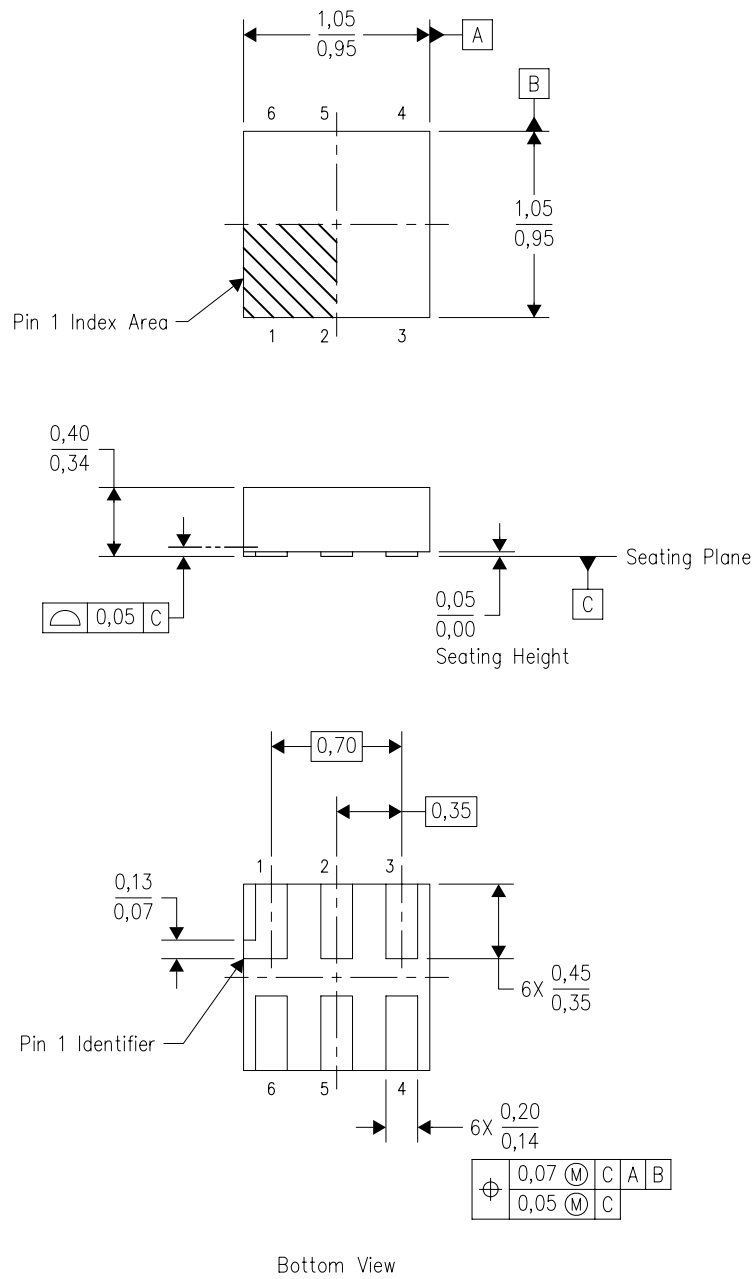
PLASTIC SMALL OUTLINE NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
  - Maximum stencil thickness 0,127 mm (5 mils). All linear dimensions are in millimeters.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Side aperture dimensions over-print land for acceptable area ratio > 0.66. Customer may reduce side aperture dimensions if stencil manufacturing process allows for sufficient release at smaller opening.

DSF (S-PX2SON-N6)

PLASTIC SMALL OUTLINE NO-LEAD



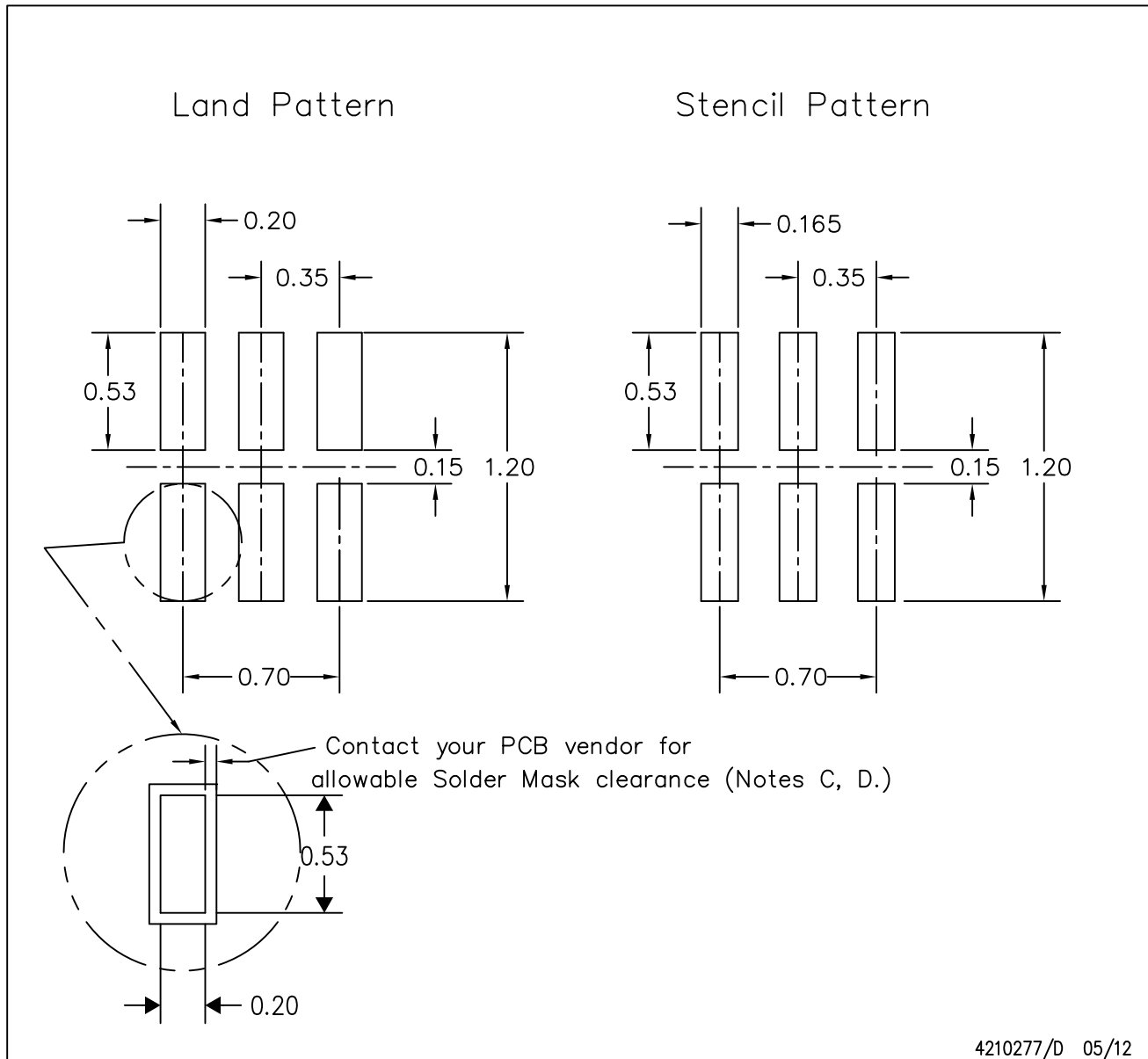
4208186/E 03/11

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - SON (Small Outline No-Lead) package configuration.
  - This package complies to JEDEC MO-287 variation X2AAF.



DSF (S-PX2SON-N6)

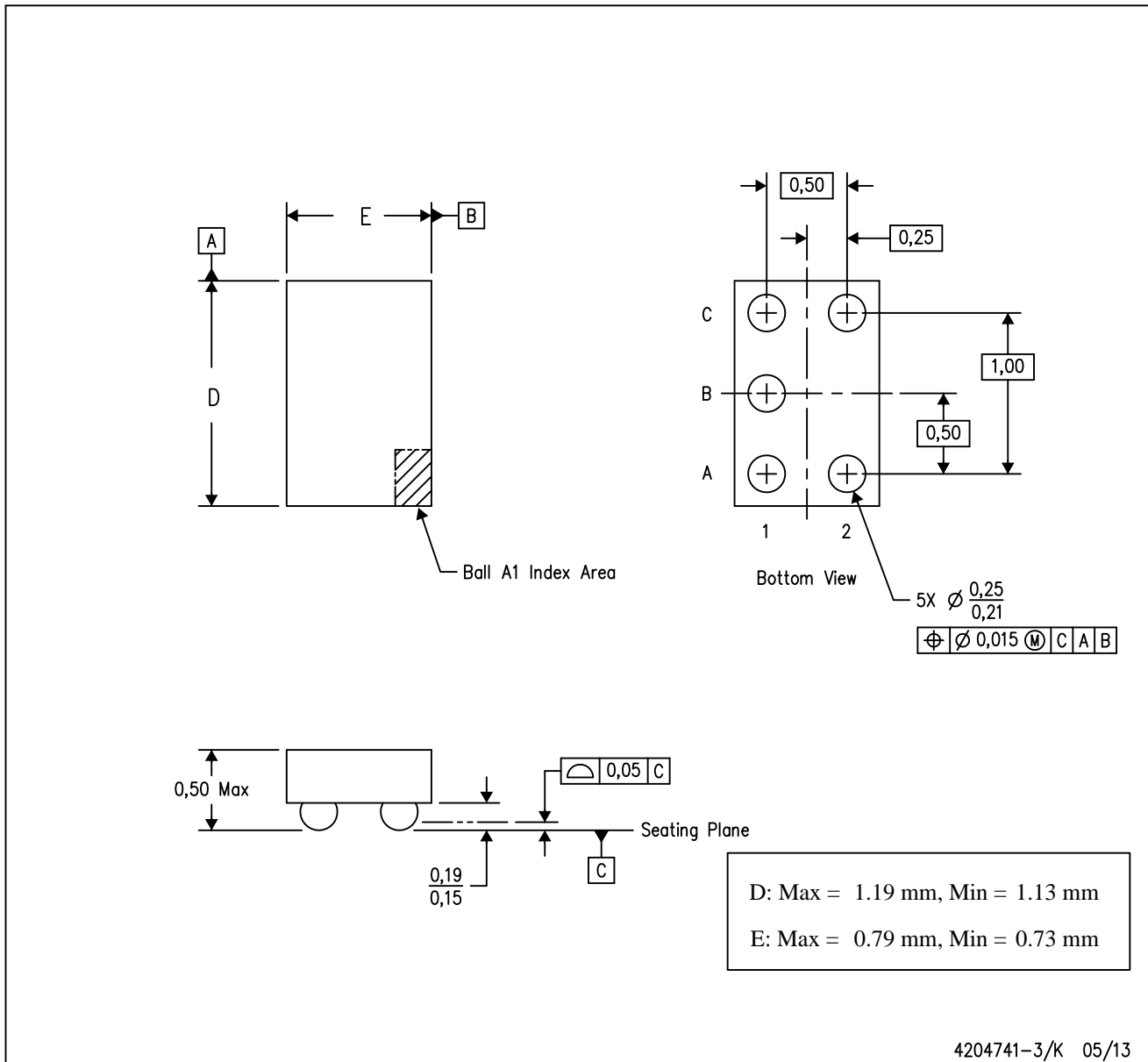
PLASTIC SMALL OUTLINE NO-LEAD



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads. If 2 mil solder mask is outside PCB vendor capability, it is advised to omit solder mask.
  - E. Maximum stencil thickness 0,1016 mm (4 mils). All linear dimensions are in millimeters.
  - F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - G. Suggest stencils cut with lasers such as Fiber Laser that produce the greatest positional accuracy.
  - H. Component placement force should be minimized to prevent excessive paste block deformation.

YZP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY

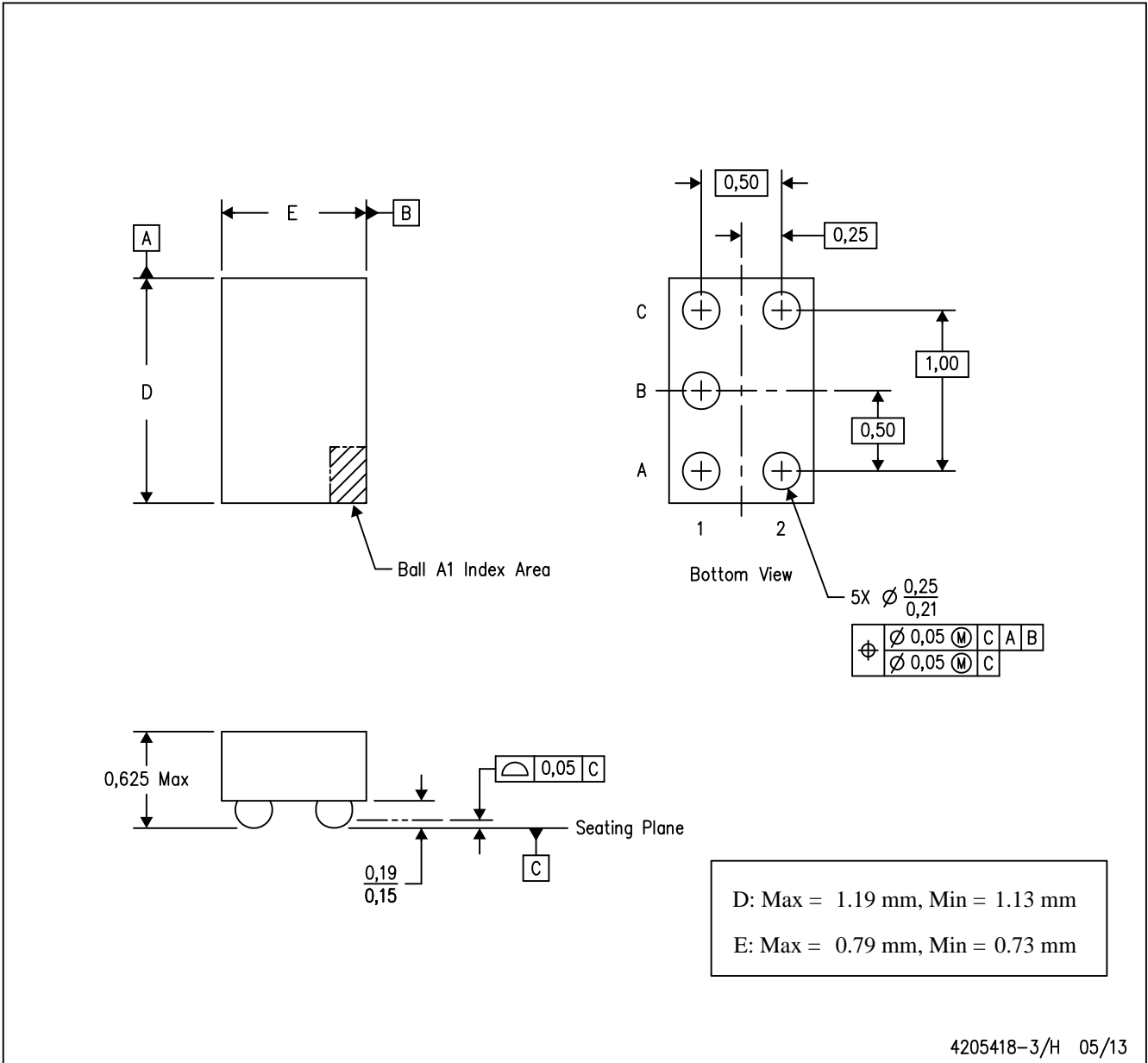


- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.

YZT (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

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| Power Mgmt                   | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers             | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                         | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Applications Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
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### Applications

|                               |                                                                                          |
|-------------------------------|------------------------------------------------------------------------------------------|
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| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Medical                       | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
| Security                      | <a href="http://www.ti.com/security">www.ti.com/security</a>                             |
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